TPS54339EVM-056, 3-A, Regulator Evaluation Module

This user's guide contains information for the TPS54339EVM-056 evaluation module as well as for the TPS54339. Included are the performance specifications, schematic, and the bill of materials of the TPS54339EVM-056.

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1   Introduction

The TPS54339 is a single, adaptive on-time, D-CAP2™-mode, synchronous buck converter requiring a low external component count. The D-CAP2™ control circuit is optimized for low-ESR output capacitors such as POSCAP, SP-CAP, or ceramic types and features fast transient response with no external compensation. The switching frequency is internally set at a nominal 600 kHz. The high-side and low-side switching MOSFETs are incorporated inside the TPS54339 package along with the gate-drive circuitry. The low drain-to-source on-resistance of the MOSFETs allows the TPS54339 to achieve high efficiencies and helps keep the junction temperature low at high-output currents. The TPS54339 dc/dc synchronous converter is designed to provide up to a 3-A output from an input voltage source of 4.5 V to 23 V. The output voltage range is from 0.76 V to 7 V. Rated input voltage and output current range for the evaluation module are given in Table 1.

The TPS54339EVM-056 evaluation module circuit is a single, synchronous buck converter providing 1.05 V at 3 A from 4.5-V to 23-V input. This user's guide describes the TPS54339EVM-056 performance.

Table 1. Input Voltage and Output Current Summary

EVM	Input Voltage Range	Output Current Range
TPS54339EVM-056	V_{IN} = 4.5 V to 23 V	0 A to 3 A

2   Performance Specification Summary

A summary of the TPS54339EVM-056 performance specifications is provided in Table 2. Specifications are given for an input voltage of V_{IN} = 12 V and an output voltage of 1.05 V, unless otherwise noted. The ambient temperature is 25°C for all measurement, unless otherwise noted.

Table 2. TPS54339EVM-056 Performance Specifications Summary

Specifications	Test Conditions	Min	Typ	Max	Unit
Input voltage range (V_{IN})		4.5	12	23	V
Output voltage			1.05		V
Operating frequency	V_{IN} = 12 V, I_O = 1.5 A		600		kHz
Output current range		0		3	A
Line regulation	I_O = 1 A		+0.4/- 0.3		%
Load regulation	V_{IN} = 12 V		+/ - 0.05		%
Overcurrent limit	V_{IN} = 12 V, L_O = 2.2 µH	3.5	4.1	5.7	A
Output ripple voltage	V_{IN} = 12 V, I_O = 3 A		15		mV_{PP}
Maximum efficiency	V_{IN} = 5 V, I_O= 0.7 A		87.5		%

3   Modifications

These evaluation modules are designed to provide access to the features of the TPS54339. Some modifications can be made to this module.

3.1   Output Voltage Setpoint

To change the output voltage of the EVMs, it is necessary to change the value of resistor R1. Changing the value of R1 can change the output voltage above 0.765 V. The value of R1 for a specific output voltage can be calculated using Equation 1.

For output voltage from 0.76 V to 7 V:

$$VO = 0.765 \times \left(1 + \frac{R1}{R2}\right)$$

(1)

Table 3 lists the R1 values for some common output voltages. For higher output voltages of 1.8 V or above, a feedforward capacitor (C4) may be required to improve phase margin. Pads for this component (C4) are provided on the printed-circuit board (PCB). Note that the resistor values given in Table 3 are standard values and not the exact value calculated using Equation 1.

Table 3. Output Voltages

Output Voltage (V)	R1 (kΩ)	R2 (kΩ)	C4 (pF) [1]			L1 (µH)			C8 + C9 + C10 (µF)	
			Min	Typ	Max	Min	Typ	Max	Min	Max
1	6.81	22.1	5	150	220	1.5	2.2	4.7	22	68
1.05	8.25	22.1	5	150	220	1.5	2.2	4.7	22	68
1.2	12.7	22.1	5		100	1.5	2.2	4.7	22	68
1.5	21.5	22.1	5		68	1.5	2.2	4.7	22	68
1.8	30.1	22.1	5		22	2.2	3.3	4.7	22	68
2.5	49.9	22.1	5		22	2.2	3.3	4.7	22	68
3.3	73.2	22.1	5		22	2.2	3.3	4.7	22	68
5	124	22.1	5		22	3.3		4.7	22	68
6.5	165	22.1	5		22	3.3		4.7	22	68

[1]   Optional

3.2   Output Filter and Closed-Loop Response

The TPS54339 relies on the output filter characteristics to ensure stability of the control loop. The recommended output filter components for common output voltages are given in Table 3. It may be possible for other output filter component values to provide acceptable closed-loop characteristics. R3 and TP4 are provided for convenience in breaking the control loop and measuring the closed-loop response.

4   Test Setup and Results

This section describes how to properly connect, set up, and use the TPS54339EVM-056. The section also includes test results typical for the evaluation modules and efficiency, output load regulation, output line regulation, load transient response, output voltage ripple, input voltage ripple, start-up, and switching frequency.

4.1   Input/Output Connections

The TPS54339EVM-056 is provided with input and output connectors and test points as shown in Table 4. A power supply capable of supplying 2 A must be connected to J1 through a pair of 20 AWG wires. The load must be connected to J2 through a pair of 20 AWG wires. The maximum load current capability is 3 A. Wire lengths must be minimized to reduce losses in the wires. Test point TP1 provides a place to monitor the V_{IN} input voltages with TP2 providing a convenient ground reference. TP8 is used to monitor the output voltage with TP9 as the ground reference.

Table 4. Connection and Test Points

Reference Designator	Function
J1	V_{IN} (see Table 1 for V_{IN} range)
J2	V_{OUT}, 1.05 V at 3-A maximum
JP1	EN control. Connect EN to OFF to disable, connect EN to ON to enable
TP1	V_{IN} test point at V_{IN} connector
TP2	GND test point at V_{IN} connector
TP3	EN test point
TP4	Loop response measurement test point
TP5	VREG5 test point
TP6	Switch node test point

Table 4. Connection and Test Points (continued)

Reference Designator	Function
TP7	Analog ground test point
TP8	Output voltage test point at V_{OUT} connector
TP9	Ground test point at V_{OUT} connector

4.2 Start-Up Procedure

1. Ensure that the jumper at JP1 (Enable control) is set from EN to OFF.
2. Apply appropriate VIN voltage to VIN and PGND terminals at J1.
3. Move the jumper at JP1 (Enable control) to cover EN and ON. The EVM enables the output voltage.

4.3 Efficiency

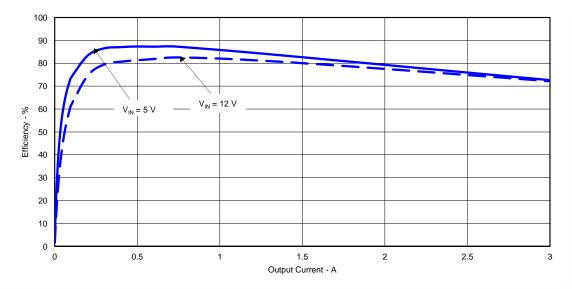Figure 1 shows the efficiency for the TPS54339EVM-056 at an ambient temperature of 25°C.

Figure 1. TPS54339EVM-056 Efficiency

Figure 2 shows the efficiency at light loads for the TPS54339EVM-056 at an ambient temperature of 25°C.
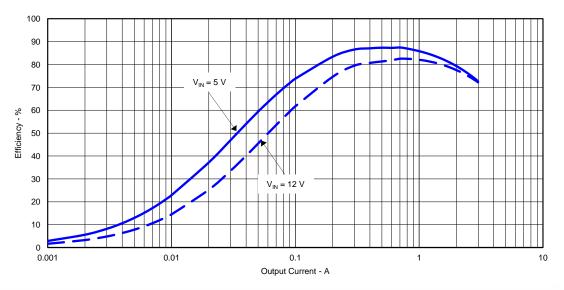

Figure 2. TPS54339EVM-056 Light-Load Efficiency

4.4 Load Regulation

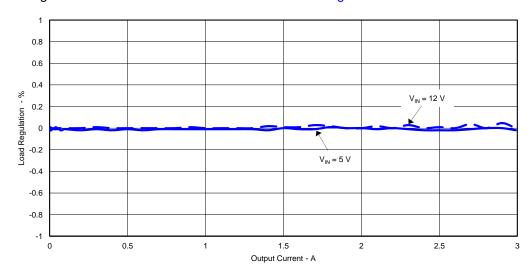The load regulation for the TPS54339EVM-056 is shown in Figure 3.

Figure 3. TPS54339EVM-056 Load Regulation, V_{IN} = 5 V and V_{IN} = 12 V

4.5 Line Regulation

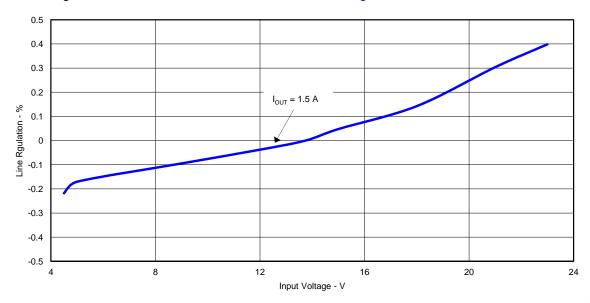The line regulation for the TPS54339EVM-056 is shown in Figure 4.

Figure 4. TPS54339EVM-056 Line Regulation

4.6 Load Transient Response

The TPS54339EVM-056 response to load transient is shown in Figure 5. The current step is from 0.75 A to 2.25 A. Total peak-to-peak voltage variation is as shown.
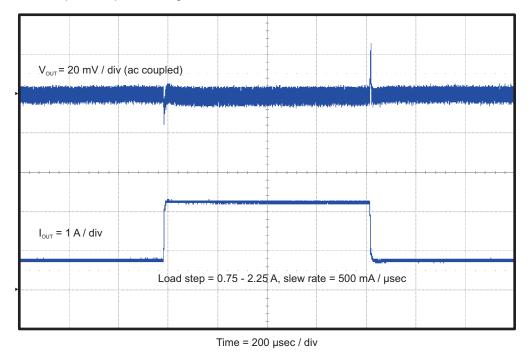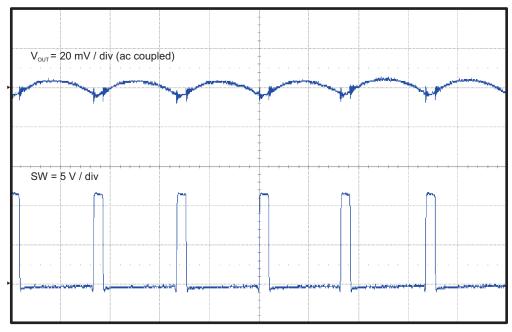

Time = 200 µsec / div

Figure 5. TPS54339EVM-056 Load Transient Response

4.7 *Output Voltage Ripple*

The TPS54339EVM-056 output voltage ripple is shown in Figure 6. The output current is the rated full load of 3 A.

Time = 1 μsec / div

Figure 6. TPS54339EVM-056 Output Voltage Ripple (I_{OUT} = 3 A)

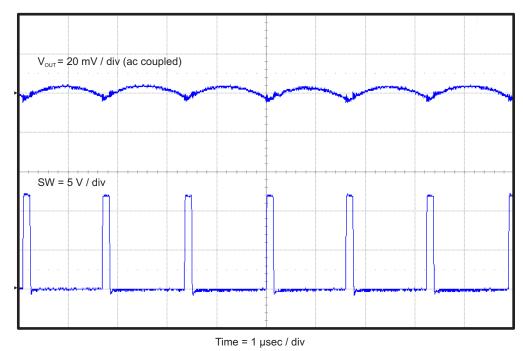The TPS54339EVM-056 output voltage ripple is shown in Figure 7. The output current is 0 A (no load).

Time = 1 μsec / div

Figure 7. TPS54339EVM-056 Output Voltage Ripple (I_{OUT} = 0 A)

4.8 *Input Voltage Ripple*

The TPS54339EVM-056 input voltage ripple is shown in Figure 8. The output current is the rated full load of 3 A.

V$_{IN}$ = 50 mV / div (ac coupled)

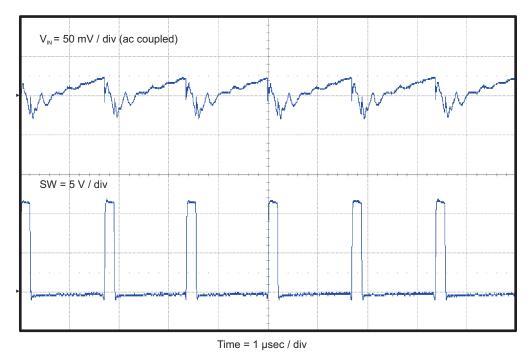SW = 5 V / div

Time = 1 µsec / div

Figure 8. TPS54339EVM-056 Input Voltage Ripple

4.9 *Start-Up*

The TPS54339EVM-056 start-up waveforms relative to V$_{IN}$ and EN are shown in Figure 9 and Figure 10. R$_{LOAD}$ = 1 Ω.

V$_{IN}$ = 10 V / div

EN = 10 V / div

SS = 5 V / div

V$_{OUT}$ = 1 V / div

Time = 2 msec / div

Figure 9. TPS54339EVM-056 Start-Up Relative to V$_{IN}$ with SS

Time = 2 msec / div

Figure 10. TPS54339EVM-056 Start-Up Relative to EN with SS

4.10 Shut-Down

The TPS54339EVM-056 shut-down waveforms relative to V_{IN} and EN are shown in Figure 11 and Figure 12. R_{LOAD} = 1 Ω.
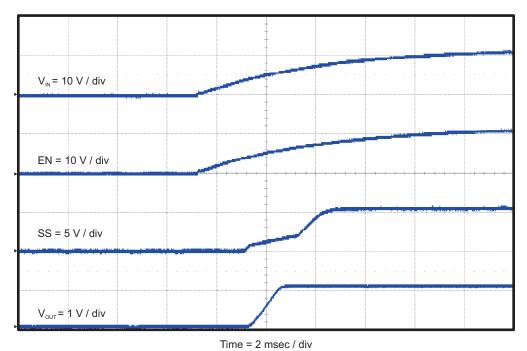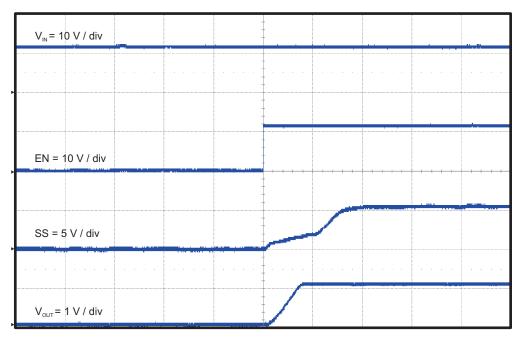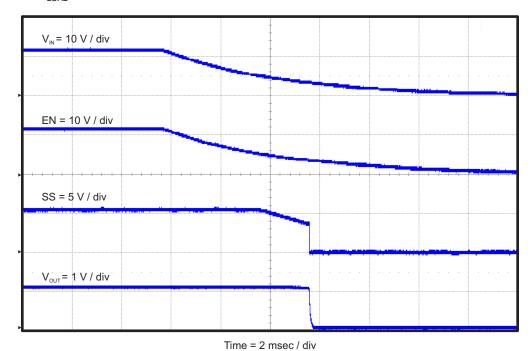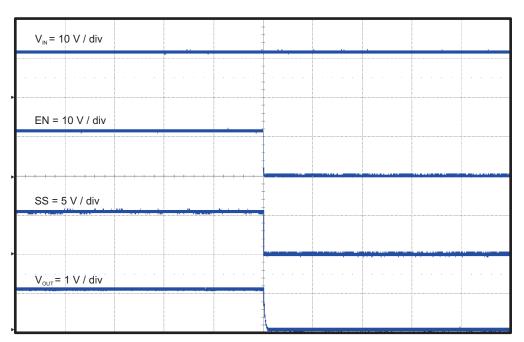

Time = 2 msec / div

Figure 11. TPS54339EVM-056 Shut-Down Relative to V_{IN} with SS

Time = 2 msec / div

Figure 12. TPS54339EVM-056 Shut-Down Relative to EN with SS

5   Board Layout

This section provides description of the TPS54339EVM-056, board layout, and layer illustrations.

5.1   Layout

The board layout for the TPS54339EVM-056 is shown in Figure 13 through Figure 17. The top layer contains the main power traces for VIN, VO, and ground. Also on the top layer are connections for the pins of the TPS54339 and a large area filled with ground. Many of the signal traces also are located on the top side. The input decoupling capacitors are located as close to the IC as possible. The input and output connectors, test points, and all of the components are located on the top side. An analog ground (GND) area is provided on the top side. Analog ground (GND) and power ground (PGND) are connected at a single point on the top layer near C6. The two internal layers are completely dedicated to power ground planes. The bottom layer is primarily power ground. A copper pour area on the bottom layer is used to connect the switching node (SW) to the output inductor and the boost capacitor. Traces also connect enable control jumper, EN, VREG5, and LOOP test points, and the feedback trace from VOUT to the voltage setpoint divider network.

Figure 13. Top Assembly

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Figure 14. Top Layer

Figure 15. Internal Layer 1

Figure 16. Internal Layer 2

Figure 17. Bottom Layer

6   Schematic, Bill of Materials, and Reference

6.1   Schematic

Figure 18 is the schematic for the TPS54339EVM-056.

Figure 18. TPS54339EVM-056 Schematic Diagram

6.2 Bill of Materials

Table 5. Bill of Materials

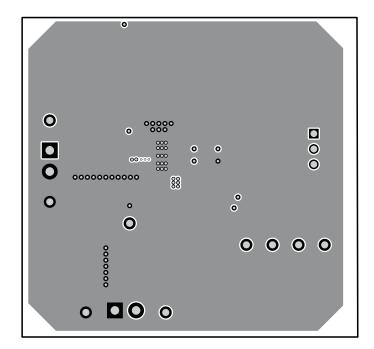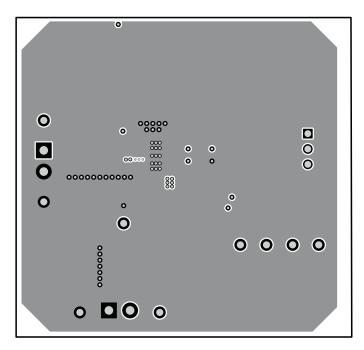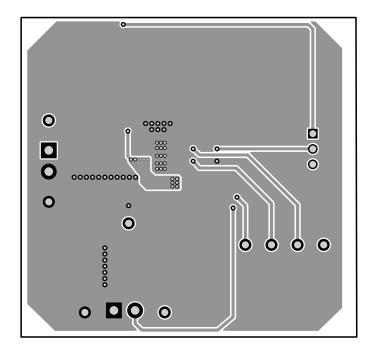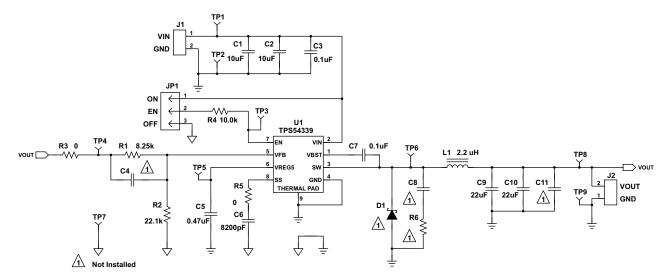| RefDes	Qty	Value	Description	Size	Part Number	MFR
C1, C2	2	10uF	Capacitor, Ceramic, 25V, X5R, 20%	1210	Std	Std
C3	1	0.1uF	Capacitor, Ceramic, 50V, X7R, 10%	1206	Std	Std
C4, C8	0	Open	Capacitor, Ceramic	0603	Std	Std
C5	1	0.47uF	Capacitor, Ceramic, 16V, X7R, 10%	0603	Std	Std
C6	1	8200pF	Capacitor, Ceramic, 25V, X7R , 10%	0603	Std	Std
C7	1	0.1uF	Capacitor, Ceramic, 50V, X7R, 10%	0603	Std	Std
C9, C10	2	22uF	Capacitor, Ceramic, 6.3V, X5R, 20%	1206	C3216X5R0J226M	TDK
C11	1	Open	Capacitor, Ceramic	1206	Std	Std
D1	0	Open	Diode, 0.5 A, 30 V, 2PIN	TUMD2	RSX051VA-30	Rohm
J1, J2	2	ED555/2DS	Terminal Block, 2-pin, 6-A, 3.5mm	0.27 x 0.25 inch	ED555/2DS	Sullins
JP1	1	PEC03SAAN	Header, Male 3-pin, 100mil spacing	0.100 inch x 3	PEC03SAAN	Sullins
L1	1	2.2uH	Inductor, SMT, 5.5A, 14.6 mΩ	0.256 x 0.280 inch	CLF7045T-2R2N	TDK
R1	1	8.25k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
R2	1	22.1k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
R3, R5	2	0	Resistor, Chip, 1/16W, 1%	0603	Std	Std
R4	1	10.0k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
R5	0	Open	Resistor, Chip, 1/16W, 1%	0603	Std	Std
TP1, TP3, TP4, TP5, TP6, TP8	3	5000	Test Point, Red, Thru Hole Color Keyed	0.100 x 0.100 inch	5000	Keystone
TP2, TP7, TP9	3	5001	Test Point, Black, Thru Hole Color Keyed	0.100 x 0.100 inch	5001	Keystone
U1	1	TPS54339DDA	IC, 4.5-23 V Input, 3-A Sync. Step-Down SWIFT Converter	SO8[DDA]	TPS54339DDA	TI
–	1		Shunt, 100-mil, Black	0.100	929950-00	3M
–	1		PCB		PWR056	Any

6.3 Reference

1. *TPS54339, 4.5-V to 23-V Input, 3-A Synchronous Step-Down SWIFT™ Converter with* data sheet (SLVSBT2)

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